

# MC74VHCT126A

## Quad Bus Buffer

### with 3-State Control Inputs

The MC74VHCT126A is a high speed CMOS quad bus buffer fabricated with silicon gate CMOS technology. It achieves noninverting high speed operation similar to equivalent Bipolar Schottky TTL while maintaining CMOS low power dissipation.

The MC74VHCT126A requires the 3-state control input (OE) to be set Low to place the output into high impedance.

The VHCT inputs are compatible with TTL levels. This device can be used as a level converter for interfacing 3.3 V to 5.0 V, because it has full 5.0 V CMOS level output swings.

The VHCT126A input structures provide protection when voltages between 0 V and 5.5 V are applied, regardless of the supply voltage. The output structures also provide protection when  $V_{CC} = 0$  V. These input and output structures help prevent device destruction caused by supply voltage – input/output voltage mismatch, battery backup, hot insertion, etc.

The internal circuit is composed of three stages, including a buffer output which provides high noise immunity and stable output. The inputs tolerate voltages up to 7.0 V, allowing the interface of 5.0 V systems to 3.0 V systems.

#### Features

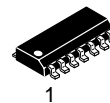
- High Speed:  $t_{PD} = 3.8$  ns (Typ) at  $V_{CC} = 5.0$  V
- Low Power Dissipation:  $I_{CC} = 4.0$   $\mu$ A (Max) at  $T_A = 25^\circ$ C
- TTL-Compatible Inputs:  $V_{IL} = 0.8$  V;  $V_{IH} = 2.0$  V
- Power Down Protection Provided on Inputs
- Balanced Propagation Delays
- Designed for 2.0 V to 5.5 V Operating Range
- Low Noise:  $V_{OLP} = 0.8$  V (Max)
- Pin and Function Compatible with Other Standard Logic Families
- Latchup Performance Exceeds 300 mA
- ESD Performance: HBM > 2000 V; Machine Model > 200 V
- Chip Complexity: 72 FETs or 18 Equivalent Gates
- Pb-Free Packages are Available\*



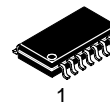
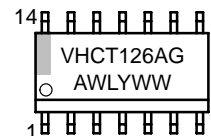
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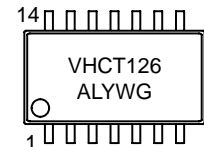
#### MARKING DIAGRAMS



SOIC-14  
D SUFFIX  
CASE 751A



SOEIAJ-14  
M SUFFIX  
CASE 965



A = Assembly Location  
WL, L = Wafer Lot  
Y = Year  
WW, W = Work Week  
G = Pb-Free Package

See Applications Note #AND8004/D for date code and traceability information.

#### FUNCTION TABLE

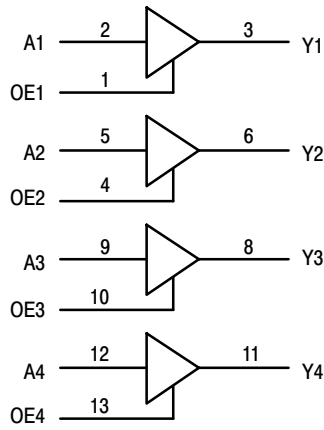
VHCT126A		
Inputs		Outputs
A	OE	Y
H	H	H
L	H	L
X	L	Z

#### ORDERING INFORMATION

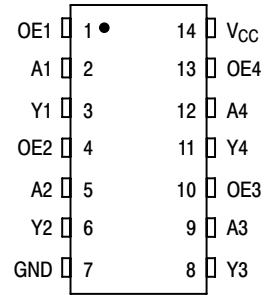
See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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**Figure 1. LOGIC DIAGRAM  
Active-High Output Enables**



**Figure 2. PIN ASSIGNMENT**

## MAXIMUM RATINGS

Rating	Symbol	Value	Unit
DC Supply Voltage	$V_{CC}$	- 0.5 to + 7.0	V
DC Input Voltage	$V_{in}$	- 0.5 to + 7.0	V
DC Output Voltage	$V_{out}$	- 0.5 to + 7.0 - 0.5 to $V_{CC} + 0.5$	V
Input Diode Current	$I_{IK}$	- 20	mA
Output Diode Current ( $V_{OUT} < GND$ ; $V_{OUT} > V_{CC}$ )	$I_{OK}$	$\pm 20$	mA
DC Output Current, per Pin	$I_{out}$	$\pm 25$	mA
DC Supply Current, $V_{CC}$ and GND Pins	$I_{CC}$	$\pm 75$	mA
Power Dissipation in Still Air, SOIC Packages† TSSOP Package†	$P_D$	500 450	mW
Storage Temperature	$T_{stg}$	- 65 to + 150	°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range  $GND \leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$ . Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or  $V_{CC}$ ). Unused outputs must be left open.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

†Derating — SOIC Packages: - 7 mW/°C from 65° to 125°C  
TSSOP Package: - 6.1 mW/°C from 65° to 125°C

## RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min	Max	Unit
DC Supply Voltage	$V_{CC}$	4.5	5.5	V
DC Input Voltage	$V_{in}$	0	5.5	V
DC Output Voltage	$V_{out}$	0 0	5.5 $V_{CC}$	V
Operating Temperature	$T_A$	- 40	+ 85	°C
Input Rise and Fall Time	$t_r, t_f$	0	20	ns/V

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## DC ELECTRICAL CHARACTERISTICS

Parameter	Test Conditions	Symbol	V <sub>CC</sub> (V)	T <sub>A</sub> = 25°C			T <sub>A</sub> ≤ 85°C		T <sub>A</sub> ≤ 125°C		Unit
				Min	Typ	Max	Min	Max	Min	Max	
Minimum High-Level Input Voltage		V <sub>IH</sub>	3.0 4.5 5.5	1.2 2.0 2.0			1.2 2.0 2.0		1.2 2.0 2.0	V	
Maximum Low-Level Input Voltage		V <sub>IL</sub>	3.0 4.5 5.5			0.53 0.8 0.8		0.53 0.8 0.8	0.53 0.8 0.8	V	
Minimum High-Level Output Voltage V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>OH</sub> = - 50 μA	V <sub>OH</sub>	3.0 4.5	2.9 4.4	3.0 4.5		2.9 4.4		2.9 4.4	V	
	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>OH</sub> = - 4.0 mA I <sub>OH</sub> = - 8.0 mA		3.0 4.5	2.58 3.94			2.48 3.80		2.34 3.66		
Maximum Low-Level Output Voltage V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>OL</sub> = 50 μA	V <sub>OL</sub>	3.0 4.5		0.0 0.0	0.1 0.1		0.1 0.1	0.1 0.1	V	
	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> I <sub>OL</sub> = 4.0 mA I <sub>OL</sub> = 8.0 mA		3.0 4.5			0.36 0.36		0.44 0.44	0.52 0.52		
Maximum Input Leakage Current	V <sub>IN</sub> = 5.5 V or GND	I <sub>IN</sub>	0 to 5.5			± 0.1		± 1.0	± 1.0	μA	
Maximum Quiescent Supply Current	V <sub>IN</sub> = V <sub>CC</sub> or GND	I <sub>CC</sub>	5.5			2.0		20	40	μA	
Quiescent Supply Current	Input: V <sub>IN</sub> = 3.4 V	I <sub>CC(T)</sub>	5.5			1.35		1.50	1.65	mA	
Maximum 3-State Leakage Current	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>I</sub> V <sub>OUT</sub> = V <sub>CC</sub> or GND	I <sub>OZ</sub>	5.5			± 0.2 5		± 2.5	± 2.5	μA	
Output Leakage Current	V <sub>OUT</sub> = 5.5 V	I <sub>OPD</sub>	0.0			0.5		5.0	10	μA	

## AC ELECTRICAL CHARACTERISTICS (Input t<sub>r</sub> = t<sub>f</sub> = 3.0 ns)

Parameter	Test Conditions	Symbol	T <sub>A</sub> = 25°C			T <sub>A</sub> ≤ 85°C		T <sub>A</sub> ≤ 125°C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
Maximum Propagation Delay, A to Y	V <sub>CC</sub> = 3.3 ± 0.3 V C <sub>L</sub> = 15 pF C <sub>L</sub> = 50 pF	t <sub>PLH</sub> , t <sub>PHL</sub>		5.6 8.1	8.0 11.5	1.0 1.0	9.5 13.0		12.0 16.0	ns
	V <sub>CC</sub> = 5.0 ± 0.5 V C <sub>L</sub> = 15 pF C <sub>L</sub> = 50 pF			3.8 5.3	5.5 7.5	1.0 1.0	6.5 8.5		8.5 10.5	
Maximum Output Enable Time, OE to Y	V <sub>CC</sub> = 3.3 ± 0.3 V C <sub>L</sub> = 15 pF R <sub>L</sub> = 1.0 kΩ C <sub>L</sub> = 50 pF	t <sub>PZL</sub> , t <sub>PZH</sub>		5.4 7.9	8.0 11.5	1.0 1.0	9.5 13.0		11.5 15.0	ns
	V <sub>CC</sub> = 5.0 ± 0.5 V C <sub>L</sub> = 15 pF R <sub>L</sub> = 1.0 kΩ C <sub>L</sub> = 50 pF			3.6 5.1	5.1 7.1	1.0 1.0	6.0 8.0		7.5 9.5	
Maximum Output Disable Time, OE to Y	V <sub>CC</sub> = 3.3 ± 0.3 V C <sub>L</sub> = 50 pF R <sub>L</sub> = 1.0 kΩ	t <sub>PLZ</sub> , t <sub>PHZ</sub>		9.5	13.2	1.0	15.0		18.0	ns
	V <sub>CC</sub> = 5.0 ± 0.5 V C <sub>L</sub> = 50 pF R <sub>L</sub> = 1.0 kΩ			6.1	8.8	1.0	10.0		12.0	
Output-to-Output Skew	V <sub>CC</sub> = 3.3 ± 0.3 V C <sub>L</sub> = 50 pF (Note 1)	t <sub>OSLH</sub> , t <sub>OSHL</sub>			1.5		1.5		2.0	ns
	V <sub>CC</sub> = 5.0 ± 0.5 V C <sub>L</sub> = 50 pF (Note 1)				1.0		1.0		1.5	
Maximum Input Capacitance		C <sub>in</sub>		4	10		10		10	pF
Maximum Three-State Output Capacitance (Output in High Impedance State)		C <sub>out</sub>		6						pF
Power Dissipation Capacitance (Note 2)		C <sub>PD</sub>	Typical @ 25°C, V <sub>CC</sub> = 5.0V							pF
			15							

- Parameter guaranteed by design. t<sub>OSLH</sub> = |t<sub>PLHm</sub> - t<sub>PLHn</sub>|, t<sub>OSHL</sub> = |t<sub>PHLm</sub> - t<sub>PHLn</sub>|.
- C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I<sub>CC(OPR)</sub> = C<sub>PD</sub> • V<sub>CC</sub> • f<sub>in</sub> + I<sub>CC</sub>/4 (per buffer). C<sub>PD</sub> is used to determine the no-load dynamic power consumption; P<sub>D</sub> = C<sub>PD</sub> • V<sub>CC</sub><sup>2</sup> • f<sub>in</sub> + I<sub>CC</sub> • V<sub>CC</sub>.

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**NOISE CHARACTERISTICS** (Input  $t_r = t_f = 3.0\text{ns}$ ,  $C_L = 50\text{pF}$ ,  $V_{CC} = 5.0\text{V}$ )

Characteristic	Symbol	$T_A = 25^\circ\text{C}$		Unit
		Typ	Max	
Quiet Output Maximum Dynamic $V_{OL}$	$V_{OLP}$	0.3	0.8	V
Quiet Output Minimum Dynamic $V_{OL}$	$V_{OLV}$	-0.3	-0.8	V
Minimum High Level Dynamic Input Voltage	$V_{IHD}$		3.5	V
Maximum Low Level Dynamic Input Voltage	$V_{ILD}$		1.5	V

## SWITCHING WAVEFORMS

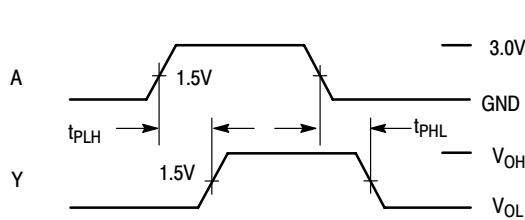


Figure 3.

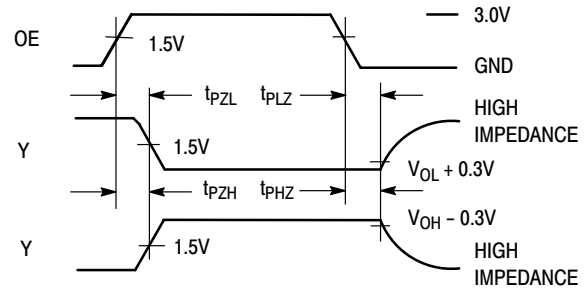
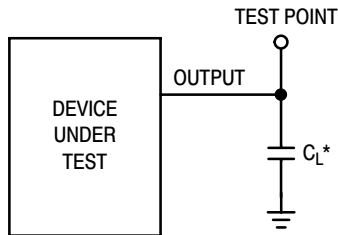
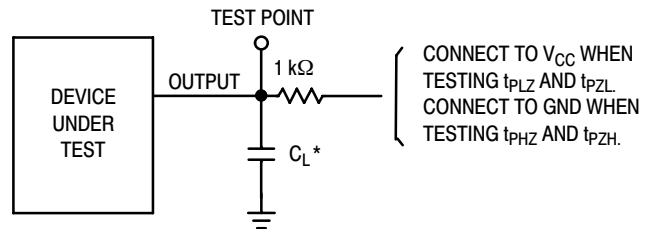


Figure 4.



\*Includes all probe and jig capacitance

Figure 5. Test Circuit



\*Includes all probe and jig capacitance

Figure 6. Test Circuit

## ORDERING INFORMATION

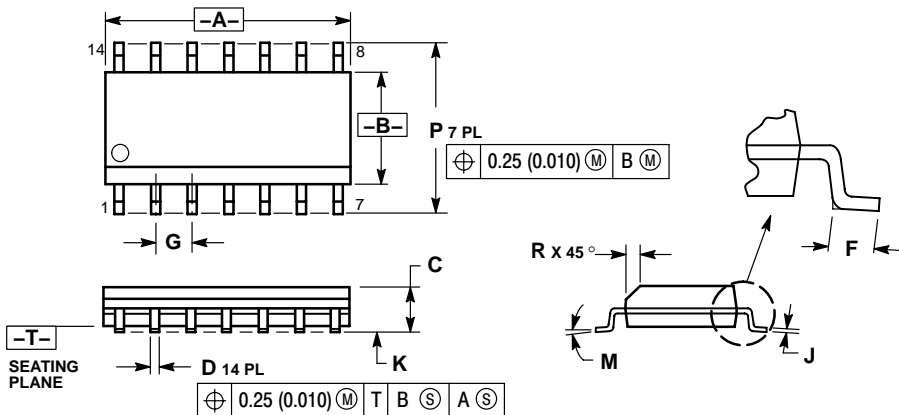
Device	Package	Shipping†
MC74VHCT126ADR2	SOIC-14	2500 / Tape & Reel
MC74VHCT126ADR2G	SOIC-14 (Pb-Free)	
MC74VHCT126AM	SOEIAJ-14	50 Units / Rail
MC74VHCT126AMG	SOEIAJ-14 (Pb-Free)	
MC74VHCT126AMEL	SOEIAJ-14	2000 / Tape & Reel
MC74VHCT126AMELG	SOEIAJ-14 (Pb-Free)	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# MC74VHCT126A

## PACKAGE DIMENSIONS

### SOIC-14 CASE 751A-03 ISSUE G

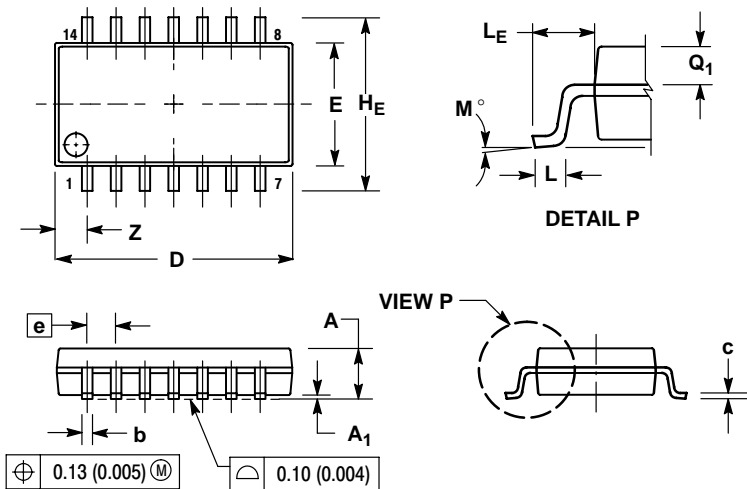


#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.55	8.75	0.337	0.344
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.228	0.244
R	0.25	0.50	0.010	0.019

### SOEIAJ-14 CASE 965-01 ISSUE A




#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	---	2.05	---	0.081
A <sub>1</sub>	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
c	0.10	0.20	0.004	0.008
D	9.90	10.50	0.390	0.413
E	5.10	5.45	0.201	0.215
e	1.27 BSC		0.050 BSC	
H <sub>E</sub>	7.40	8.20	0.291	0.323
0.50	0.50	0.85	0.020	0.033
L <sub>E</sub>	1.10	1.50	0.043	0.059
M	0°	10°	0°	10°
Q <sub>1</sub>	0.70	0.90	0.028	0.035
Z	---	1.42	---	0.056

# MC74VHCT126A

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**MC74VHCT126A/D**